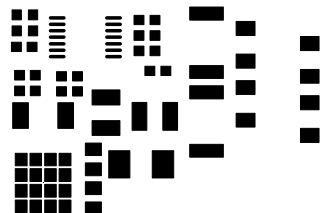
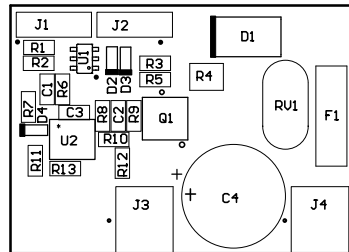


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Paste			
PLOT NAME = TIDA-00284.GTP	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



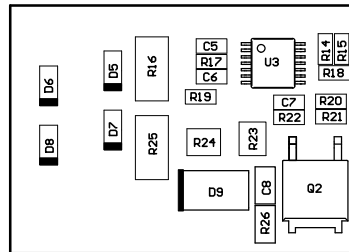
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
PLOT NAME = TIDA-00284.GBP	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	

- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
IGNORE -> ASSEMBLY TOP			
PLOT NAME = TIDA-00284.GM5	GENERATED : 9/29/2014 11:02:48 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00284	REV: E1	SVN REV: Not In VersionControl
	IGNORE -> ASSEMBLY BOTTOM		
PLOT NAME = TIDA-00284.GM6	GENERATED : 9/29/2014	11:02:48 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = TIDA-00284.GM1	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	

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